



40V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _{D Max} T _A = +25°C
40V	14mΩ @ V _{GS} = 10V	9.8A
	20mΩ @ V _{GS} = 4.5V	8.2A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions

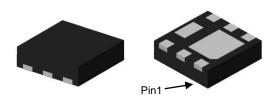
Features

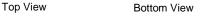
- 0.6mm Profile -Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

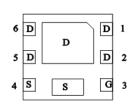
Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.007 grams (Approximate)

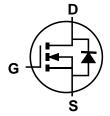
U-DFN2020-6







Pin Out Bottom View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT4012LFDF -7	U-DFN2020-6	3,000/Tape & Reel
DMT4012LFDF -13	U-DFN2020-6	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2015	2016		2017	2018		2019	2020		2021
Code	В		С	D		Е	F		G	Н		I
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	40	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) V 40.0V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.8 7.8	А
Continuous Drain Current (Note 6) V _{GS} =10.0V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	12.4 10.0	А
Outlines Dail Owner (No. 9) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	8.2 6.6	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	10.3 8.3	А
Pulsed Drain Current (10µs pulse, Duty Cycle = 1%)	I _{DM}	45	Α		
Maximum Body Diode Continuous Current (Note 6)	Is	2.2	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	12	Α		
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	7.2	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Unit		
Total Power Discination (Note 5)	T _A = +25°C	<u> </u>	0.78	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_{D}	0.50		
Thermal Basistanes, Junction to Ambient (Note 5)	Steady state	D.	160	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	100	C/VV	
Total Dawar Dissination (Note 6)	T _A = +25°C	_	2.0	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.3	VV	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	Б.	62.0	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	39.0		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	8.3			
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

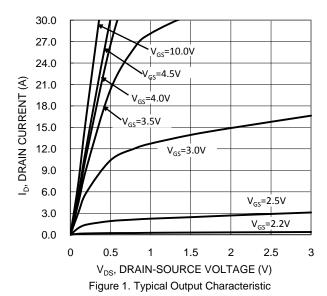
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40.0	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)	•						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			_	14	mΩ	V _{GS} = 10V, I _D = 10A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	20	11122	$V_{GS} = 4.5V, I_D = 8.5A$	
Diode Forward Voltage	V _{SD}	_	_	1.2	V	$V_{GS} = 0V, I_{S} = 2A$	
DYNAMIC CHARACTERISTICS (Note 9)	•						
Input Capacitance	C _{iss}	_	907		pF		
Output Capacitance	Coss	_	376	_	pF	$V_{DS} = 20V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	43	_	pF	1 - 1.000112	
Gate Resistance	Rg	_	1.5		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	7	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	15	_	nC	7, 20,4 40,4	
Gate-Source Charge	Q _{gs}	_	2.5	_	nC	$V_{DD} = 20V, I_{D} = 10A$	
Gate-Drain Charge	Q_{gd}	_	2.3	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.1	_	ns		
Turn-On Rise Time	t _R	_	5.1	_	ns	$V_{DS} = 20V, I_{D} = 10A$	
Turn-Off Delay Time	t _{D(OFF)}	_	14.1	_	ns	$V_{GS} = 10V$, $R_G = 6\Omega$	
Turn-Off Fall Time	t _F	_	6.2	_	ns		
Reverse Recovery Time	t _{RR}	_	20.6	_	ns	1 400 4:/4+ 4000/	
Reverse Recovery Charge	Q _{RR}	_	8.8	_	nC	$I_F = 10A$, di/dt = 100A/ μ s	

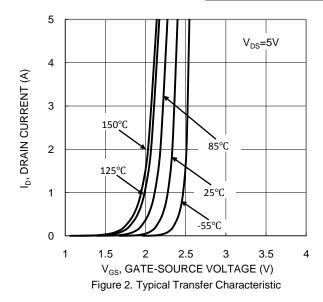
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C. Notes:

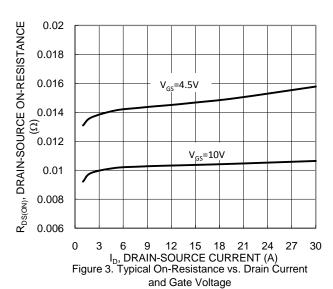
8. Short duration pulse test used to minimize self-heating effect.

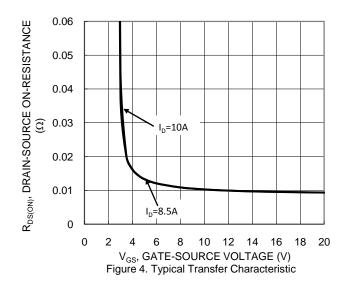
9. Guaranteed by design. Not subject to product testing.

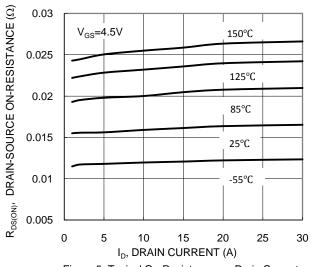












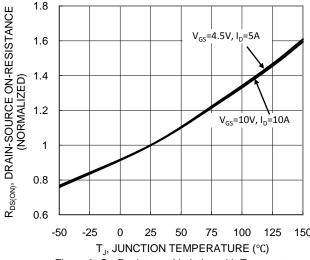
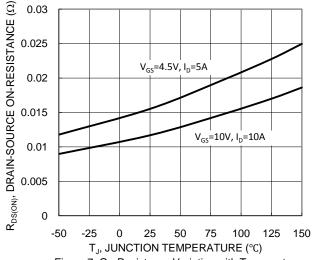
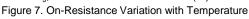


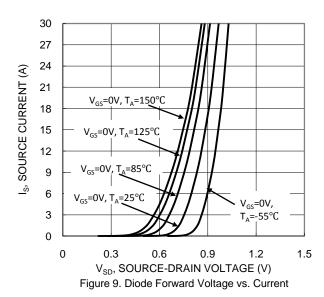
Figure 5. Typical On-Resistance vs. Drain Current and Temperature

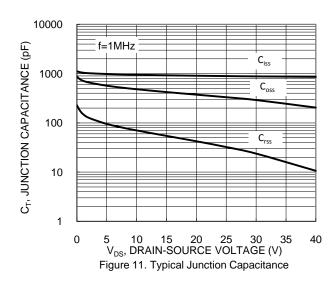
Figure 6. On-Resistance Variation with Temperature

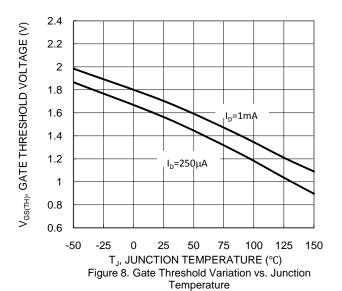












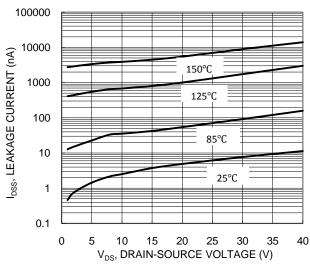
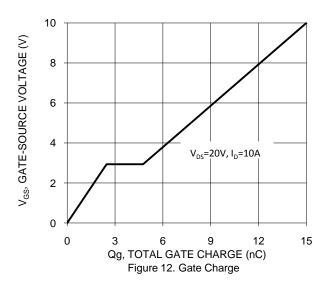
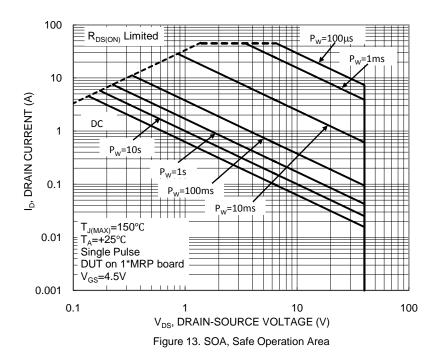


Figure 10. Typical Drain-Source Leakage Current vs. Voltage







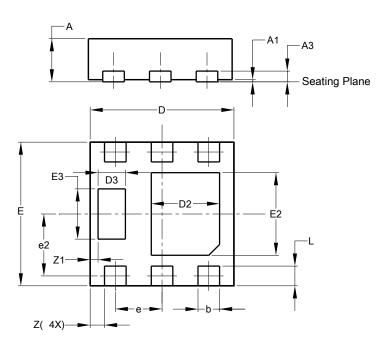
D=0.5 D=0.7 D=0.9 r(t), TRANSIENT THERMAL RESISTANCE D=0.3 0.1 D=0.1 D=0.05 D=0.02 0.01 D=0.01 D=0.005 $R_{\theta JA}(t)=r(t) * R_{\theta JA}$ $R_{\theta JA}$ =159°C/W D=Single Pulse Duty Cycle, D=t1 / t2 0.001 1E-05 0.0001 0.001 1000 0.01 0.1 1 100 t1, PULSE DURATION TIME (sec)

Figure 14. Transient Thermal Resistance



Package Outline Dimensions

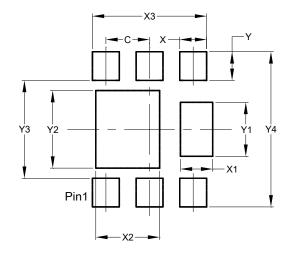
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-DFN2020-6 (Type F)						
Dim	Min Max Typ					
Α	0.57	0.63	0.60			
A1	0	0.05	0.03			
А3	-	-	0.15			
b	0.25	0.35	0.30			
D	1.95	2.05	2.00			
D2	0.85	1.05	0.95			
D3	0.33	0.43	0.38			
е	0.65 BSC					
e2	C).863 B	SC			
Е	1.95	2.05	2.00			
E2	1.05	1.25	1.15			
E3	0.65	0.75	0.70			
L	0.225	0.325	0.275			
Z	0.20 BSC					
Z 1	0.110 BSC					
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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